# **WIMA MP 3-Y2**

## Metallized Paper (MP) **RFI-Capacitors Class Y2** PCM 10 mm and 15 mm

## **Special Features**

- Particularly high reliability against active and passive flammability
- Excellent self-healing as well as high voltage strength High degree of interference
- suppression due to good attenuation and low ESR
- For temperatures up to +110°C According to RoHS 2002/95/EC

## **Typical Applications**

### **Class Y2 RFI applications to meet EMC** regulations

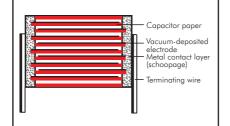
- Capacitors connected to the mains between phase or neutral and earthed casing
- By-passing of the basic or supplementary insulation, pulse peak voltage ≤ 5 kV

## Construction

### **Dielectric:**

Paper, epoxy resin impregnated **Capacitor electrodes:** Vacuum-deposited

Internal construction:



## **Encapsulation:**

Self-extinguishing epoxy resin, UL 94 V-0. metal foil

**Terminations:** 

### Tinned wire.

Marking:

Marking: Black on Silver.

## **Electrical Data**

## **Capacitance range:**

1000 pF to 0.022 µF (E12-values on request) **Rated voltages:** 

250 VAC Capacitance tolerances: +20% **Operating temperature range:** 

-40° C to +110° C **Climatic test category:** 

40/110/56/C in accordance with IEC **Insulation resistance** at +20° C:

 $\geq 12 \times 10^3 M\Omega$ 

Measuring voltage: 100 V/1 min.

**Dissipation factors:** tan  $\delta \leq 13 \times 10^{-3}$  at 1 kHz and +20° C

**Test specifications:** 

In accordance with DIN EN 132400

## Approvals:

## 2200 ... 4700 6800 ... 0.022 for pulses equal to the rated voltage, $U_{pp} = 355 V$

**Test voltage:** 2700 VDC, 2 sec. **Reliability:** 

Maximum pulse rise time:

Capacitance

pF/µF

1000

1500

Operational life > 300,000 hours Failure rate < 1 fit (0.5 x U<sub>r</sub> and 40° C)

Country	Authority	Specification	Symbol	Approval-No.
Germany	VDE	DIN EN 132400 IEC 60384-14/2	EN 132 400	87455
USA	UL	UL 1283	1.2	E 100438
Canada	CSA	C 22.2 No. 8	(f)	LR 93312-1

## Packing

Available taped and reeled.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.

00.00



Pulse rise time V/µsec

max. operation

1000

600

450

300

# WIMA MP 3-Y2

## Continuation

## **General Data**

Care a citera co	250 VAC*						
Capacitance	W	Н	L	PCM**			
1000 pF	4	8.5	13.5	10			
1500 "	4	8.5	13.5	10			
2200 "	4	8.5	13.5	10			
3300 "	4	8.5	13.5	10			
4700 "	5	10	13.5	10			
6800 "	5	13	19	15			
0.01 µF	5	13	19	15			
0.015 "	6	14	19	15			
0.022 "	7	15	19	15			

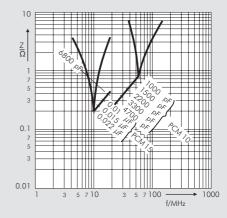
\* f = 50/60 Hz

\*\* PCM = Printed circuit module = lead spacing

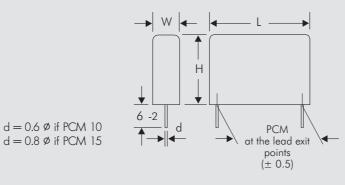
Upon request with long leads 35-2 mm max.

Dims. in mm.

Taped version see page 104.



Impedance change with frequency (general guide)



Rights reserved to amend design data without prior notification.

## **Recommendation for Processing** and Application of **Through-Hole Capacitors**

### **Soldering Process**

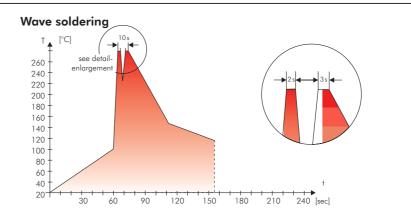
A preheating of through-hole WIMA capacitors is allowed for temperatures T<sub>max</sub> < 100 ° C. In practice a preheating duration of t < 5 min. has been proven to be best.

### Single wave soldering

Soldering bath temperature:  $T < 260 \circ C$ Immersion time: t < 5 sec

### Double wave soldering

Soldering bath temperature:  $T < 260 \,^{\circ}$  C Immersion time:  $2 \times t < 3 \sec \theta$ 



Temperature/time graph for the maximum permissible solder bath temperature for the wave soldering of through-hole WIMA capacitors

- PBB/PBDE

- Arsenic

- Mercury

- etc.

## •WIMA Quality and Environmental Philosophy•

## ISO 9001:2000 Certification

ISO 9001:2000 is an international basic standard of quality assurance systems for all branches of industry. The approval according to ISO 9001:2000 of our factories by the VDE inspectorate certifies that organisation, equipment and monitoring of quality assurance in our factories correspond to internationally recognized standards.

## WIMA WPCS

The WIMA Process Control System (WPCS) is a quality surveillance and optimization system developed by WIMA. WPCS is a major part of the quality-oriented WIMA production. Points of application of WPCS during production process:

- incoming material inspection
- metallization
- film inspection
- schoopage
- pre-healing lead attachment
- cast resin preparation/ encapsulation
- 100% final inspection
- AQL check

## **WIMA Environmental Policy**

All WIMA capacitors, irrespective of whether through-hole devices or SMD, are made of environmentally friendly materials. Neither during manufacture nor in the product itself any toxic substances are used, e.g.

- Lead

- PCB
- CFC
- Hvdrocarbon chloride - Chromium 6+

We merely use pure, recyclable materials for packing our components, such as:

- carton
- cardboard
- adhesive tape made of paper
- polystyrene

We almost completely refrain from using packing materials such as:

- foamed polystyrene (Styropor®)
- adhesive tapes made of plastic
- metal clips

## **RoHS** Compliance

According to the RoHS Directive 2002/95/EC certain hazardous substances like e.g. lead, cadmium, mercury must not be used any longer in electronic equipment as of July 1st, 2006. For the sake of the environment WIMA has refraind from using such substances since years already.



Tape for lead-free WIMA capacitors

## **DIN EN ISO 14001:2005**

WIMA's environmental management has been established in accordance with the auidelines of DIN EN ISO 14001:2005. The certification has been granted in June 2006.



## Typical Dimensions for Taping Configuration

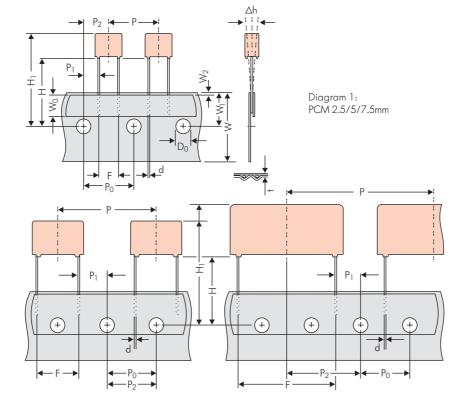


Diagram 2: PCM 10/15 mm

Diagram 3: PCM 22.5 and 27.5\*mm \*PCM 27.5 taping possible with two feed holes between components

		Dimensions for Radial Taping							
Designation	Symbol	PCM 2.5 taping	PCM 5 taping	PCM 7.5 taping	PCM 10 taping*	PCM 15 taping*	PCM 22.5 taping	PCM 27.5 taping	
Carrier tape width	W	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	
Hold-down tape width	W <sub>0</sub>	6.0 for hot-sealing adhesive tape	6.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	
Hole position	W <sub>1</sub>	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	
Hold-down tape position	W <sub>2</sub>	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	
Feed hole diameter	D <sub>0</sub>	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	
Pitch of component	Р	12.7 ±1.0	12.7 ±1.0	12.7 ±1.0	25.4 ±1.0	25.4 ±1.0	38.1 ±1.5	38.1 ±1.5 or 50.8 ±1.5	
Feed hole pitch	Po	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error mox. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	
Feed hole centre to lead	P1	5.1 ±0.5	3.85 ±0.7	2.6 ±0.7	7.7 ±0.7	5.2 ±0.7	7.8 ±0.7	5.3 ±0.7	
Hole centre to component centre	P <sub>2</sub>	6.35 ±1.3	6.35 ±1.3	6.35 ±1.3	12.7 ±1.3	12.7 ±1.3	19.05 ±1.3	19.05 ±1.3	
Feed hole centre to bottom	Н▲	16.5 ±0.3	16.5 ±0.3	16.5 ±0.5	16.5 ±0.5	16.5 ±0.5	16.5 ±0.5	16.5 ±0.5	
edge of the component		18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	
Feed hole centre to top edge of the component	H1	H+H <sub>component</sub> < H <sub>1</sub> 32.25 max.	H+H <sub>component</sub> < H <sub>1</sub> 32.25 max.	H+H <sub>component</sub> < H <sub>1</sub> 24.5 to 31.5	H+H <sub>component</sub> < H <sub>1</sub> 25.0 to 31.5	H+H <sub>component</sub> < H <sub>1</sub> 26.0 to 37.0	H+H <sub>component</sub> < H <sub>1</sub> 30.0 to 43.0	H+H <sub>component</sub> < H <sub>1</sub> 35.0 to 45.0	
Lead spacing at upper edge of carrier tape	F	2.5 ±0.5	5.0 <sup>+0.8</sup> <sub>-0.2</sub>	7.5 ±0.8	10.0 ±0.8	15 ±0.8	22.5 ±0.8	27.5 ±0.8	
Lead diameter	d	0.4 ±0.05	0.5 ±0.05	$^{\circ}0.5 \pm 0.05 \text{ or } 0.6 + 0.06 \\ -0.05$	$^{\circ}0.5 \pm 0.05 \text{ or } 0.6 + 0.06 - 0.05$	0.8 +0,08	0.8 +0,08	0.8 +0.08	
Component alignment	Δh	± 2.0 max.	± 2.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	
Total tape thickness	t	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	
		ROLL//	AMMO	AMMO					
Package (see also page 105)	•	REEL Ø 360 max. Ø 30 ±1	$\left. B \begin{array}{c} 52 \pm 2 \\ 58 \pm 2 \end{array}  ight\}  depending on \ comp. dimensions$		REEL \$\overline{\phi}\$ 360 max. B 52 \pm 2 \overline{\phi}\$ 52 \pm 2 \overline{\phi}\$ 8 58 \pm 2 \overline{\phi}\$ 66 \pm 2 \overline{\pm}\$ 10 \overlin{\pm}\$ 10 \overline{\pm}\$ 10 \over				
Unit		see details page 107.							

 $\blacktriangle$  Please give "H" dimensions and desired packaging type when ordering.

• Diameter of leads see General Data.

PCM 10 and PCM 15 can be crimped to PCM 7.5. Position of components according to PCM 7.5 (sketch 1).  $P_0 = 12.7$  or 15.0 is possible

Please clarify customer-specific deviations with the manufacturer.

Dims in mm.